SPN4402W N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN4402W is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.

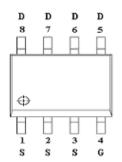
FEATURES

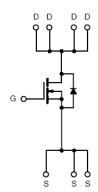
- 30V/12A,RDS(ON)= $15m\Omega$ @VGS=10V
- 30V/10A,RDS(ON)= $18m\Omega$ @VGS=4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOP-8 package design

APPLICATIONS

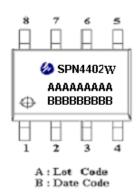
- Power Management in Note book
- Battery Powered System
- DC/DC Converter
- Load Switch
- LCD Display inverter

PIN CONFIGURATION(SOP-8)





PART MARKING



PIN PEGGPIPEYON						
IN DESCRIPTION						
Pin	Symbol	Description				
1	S	Source				
2	S	Source				
3	S	Source				
4	G	Gate				
5	D	Drain				
6	D	Drain				
7	D	Drain				
8	D	Drain				

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN4402WS8RGB	SOP-8	SPN4402W

[※] SPN4402WS8RGB: 13" Tape Reel; Pb − Free; Halogen − Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

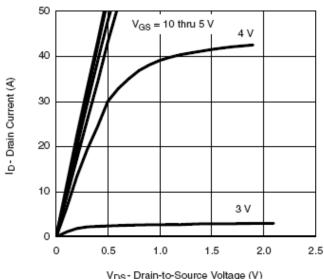
Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	30	V	
Gate –Source Voltage		VGSS	±20	V	
Continuous Dusin Cumant/Ty-1509C)	Ta=25°C	In	12	A	
Continuous Drain Current(T _J =150°C)	Ta=70°C	- Id	10	A	
Pulsed Drain Current		Ірм	30	A	
Continuous Source Current(Diode Conduction)		Is	2.3	A	
Decree Discipation	Ta=25°C	PD	2.5	W	
Power Dissipation	Ta=70°C		1.6	W	
Operating Junction Temperature		TJ	-55/150	°C	
Storage Temperature Range		Tstg	-55/150	°C	
Thermal Resistance-Junction to Ambient		RθJA	80	°C/W	

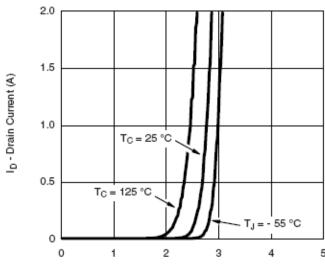
ELECTRICAL CHARACTERISTICS

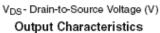
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static			<u>'</u>			<u>,I</u>
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=250uA	30			.8 V
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.6		1.8	
Gate Leakage Current	Igss	VDS=0V,VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=24V,VGS=0V			1	uA
		V _{DS} =24V,V _{GS} =0V T _J =55°C			5	
On-State Drain Current	ID(on)	VDS≥5V,VGS =10V	25			A
Drain-Source On-Resistance	D	Vgs= 10V,Id=12A		0.010	0.015	Ω
Drain-Source On-Resistance	RDS(on)	Vgs=4.5V,Id=10A		0.013	0.018	
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S
Diode Forward Voltage	Vsd	Is=2.3A,VGS =0V		0.5	1.0	V
Dynamic						
Total Gate Charge	Qg	VDS=15V,VGS=10V -ID= 2A		10	18	nC
Gate-Source Charge	Qgs			2.8		
Gate-Drain Charge	Qgd			2.0		
Input Capacitance	Ciss	VDS=15VGS=0V f=1MHz		850		pF
Output Capacitance	Coss			158		
Reverse Transfer Capacitance	Crss			120		
Turn-On Time	td(on)			10	15	
	tr	$V_{DD}=15V,RL=15\Omega$		4	12	nS
Turn-Off Time	td(off)	$I_D\equiv 5.0A, V_{GEN}=10V$ $R_G=1\Omega$		15	30	
	tf			10	15	

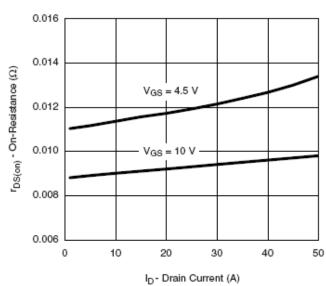
TYPICAL CHARACTERISTICS

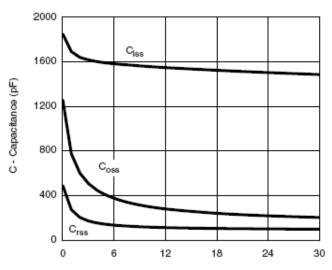










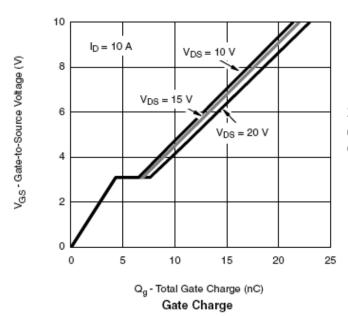


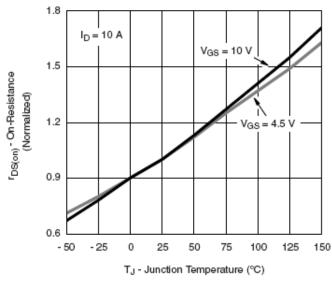
On-Resistance vs. Drain Current and Gate Voltage

V_{DS}- Drain-to-Source Voltage (V)

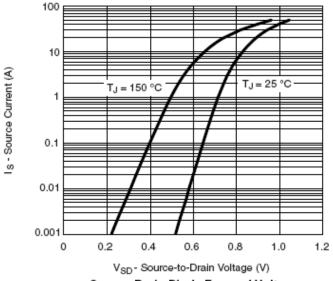
Capacitance

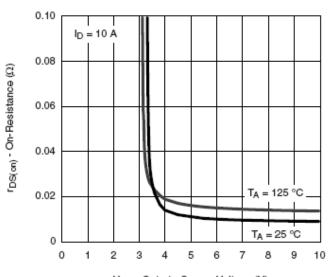
TYPICAL CHARACTERISTICS





On-Resistance vs. Junction Temperature

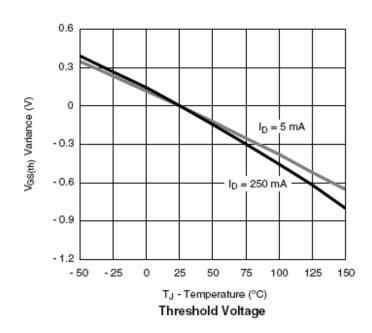


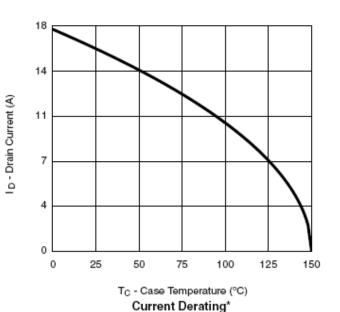


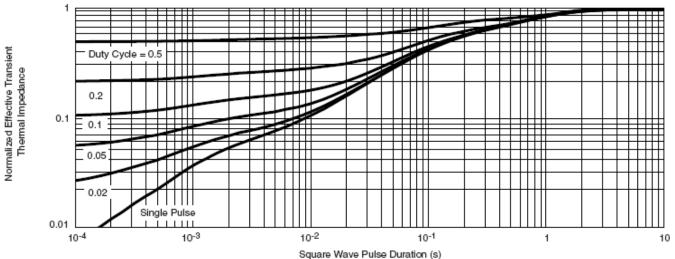
Source-Drain Diode Forward Voltage

V_{GS} - Gate-to-Source Voltage (V)
On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS







Normalized Thermal Transient Impedance, Junction-to-Case

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